



Materials Declaration Form

IPC Form Type *	1752 Distribute	Version	2
Sectionals *	Material Info Manufacturing Info	Subsectionals *	A-D <i>* : Required Field</i>

Supplier Information			
Company Name *	STMicroelectronics	Response Date *	2020-02-06
Company Unique ID	NL 008751171B01		
Contact Name *	Refer to Supplier Comment section		Refer to Supplier Comment section
Contact Phone *	Refer to Supplier Comment section	Contact Email *	Refer to Supplier Comment section
Authorized Representative *	Floriana SAN BIAGIO	Representative Title	AMS MD CHAMPION
Representative Phone *	Refer to Supplier Comment section	Representative Email *	Refer to Supplier Comment section
Supplier Comment	Online Technical Support - STMicroelectronics : http://www.st.com/web/en/support/support.html		

Uncertainty Statement


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Legal Statement	
Supplier Acceptance *	true
Legal Declaration *	Standard

Legal Statement

Supplier certifies that it gathered the provided information and such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part(s), and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part(s), the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusive source of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form.

Product				
Mfr Item Number	Mfr Item Name	Version	Mfr Site	Date
	2RX0*UM64J51	A	9957	2020-02-06
Amount	UoM	Unit type	ST ECOPACK Grade	
20.8	mg	Each	ECOPACK® 2	
Comment	ECOPACK® 2 is STMicroelectronics trade name for ROHS compliant device without Brominated and Chlorinated compound (900ppm) and without Antimony oxide flame retardant (in each organic material)			

Manufacturing information				
J-STD-020 MSL Rating	Classification Temp	Nbr of Reflow Cycles		 life.augmented
1	260	3		
Bulk Solder Termination	Terminal Plating	Terminal Base Alloy	Comment	
Not Applicable	Tin (Sn), matte, annealed	Copper Alloy	0	

Package Designator	Size	Nbr of instances	Shape	
QFN	3 x 3	8	flat	
Comment	X0 VDFPN 3x3x1.0 8 PITCH 0.50; MDF is valid for STCS1PUR			

QueryList : RoHS Directive 2011/65/EU-July 2011 – Annex II amended by Directive 2015/863-March 2015	
Query	Response
1 - Product(s) meets EU RoHS requirement without any exemptions	TRUE
2 - Product(s) meets EU RoHS requirements except lead in solder and this usage may qualify under the lead in solder '7b' exemption (other selected exemptions may apply)	FALSE
3 - Product(s) meets EU RoHS requirements by application of the selected exemption(s)	FALSE
4 - Product(s) does not meet EU RoHS requirements and is not under exemptions	FALSE
Exemption Id.	Description

QueryList : ELV directive : 2000/53/EC amended 2017/2096 _November 2017	
Query	Response
1 - Product(s) meets EU ELV requirements without any exemptions	TRUE
2 - Product(s) meets EU RoHS requirements by application of the selected exemption(s)	FALSE
Exemption Id.	Description

QueryList : California Prop65 list, dated 3rd January 2020			
Query			Response
1 - The product does not contain identified substance from California Prop 65 List, no exposure to consumers is foreseen			FALSE
2 - The product is containing below substance(s) from California Prop 65 List, no exposure to consumers is foreseen			TRUE
Substance	amount in product (mg)	Application	ppm in product
Nickel	0.004	die	192

QueryList : REACH-16th January 2020				
Query				Response
1 - Product(s) does not contain REACH Substances Of Very High Concern above the limits per the definition within REACH				TRUE
CategoryLevel_Name	CategoryLevel_Threshold	amount in product (mg)	Application	ppm in product
2 - Product(s) does not contain REACH Substances Of Very High Concern in any Embedded article nor Homogeneous Material above the limits per the definition within REACH				TRUE
CategoryLevel_Name	CategoryLevel_Threshold	Amount in Embedded Article / Homogeneous Material (mg)	Application - Article / Homogeneous Material	ppm in Article /Homogeneous Material

QueryList : Korea Chemical Control Act_27 Dec 2017 update				
Query				Response
The Product does contain at least one of the substances listed in Chemical Control Act				NO
Substance	Homogeneous Material impacted	Content in Homogeneous Material (mg)	Concentration in the material(%)	Application Purpose

Material Composition Declaration : note : Substance present with less 0.001mg will not be declared in this document						Mfr item Name	2RX0*UM64J51				5999892.0	1002930.0
Homogeneous Material	Material Group	Mass	UoM	Level	Substance Category	Substance	CAS	Exempt	Mass	UoM	Concentration in homogeneous material (ppm)	Concentration in product (ppm)
Die	M-011 Other inorganic materials	1.186	mg	supplier	die	Silicon(Si)	7440-21-3		1.124	mg	947723	54038
				supplier	metallisation	Aluminium(Al)	7429-90-5		0.012	mg	10118	577
				supplier	metallisation	Chromium(Cr)	7440-47-3		0.001	mg	843	48
				supplier	metallisation	Gold(Au)	7440-57-5		0.002	mg	1686	96
				supplier	metallisation	Nickel(Ni)	7440-02-0		0.004	mg	3373	192
				supplier	metallisation	Tungsten(W)	7440-33-7		0.009	mg	7589	433
				supplier	Passivation	Silicon nitride(SiN)	12033-89-5		0.002	mg	1686	96
				supplier	passivation	Silicon oxide	7631-86-9		0.020	mg	16863	962
Leadframe	M-004 Copper and its alloys	9.416	mg	supplier	polymer coating	polyimide	proprietary		0.012	mg	10118	577
				supplier	alloy & coating	Copper(Cu)	7440-50-8		9.095	mg	965909	437260
				supplier	alloy & coating	Iron(Fe)	7439-89-6		0.212	mg	22515	10192
				supplier	alloy & coating	Phosphorus metal	7723-14-0		0.002	mg	212	96
				supplier	alloy & coating	Zinc(Zn)	7440-66-6		0.012	mg	1274	577
Die attach	M-015 Other organic materials	0.030	mg	supplier	alloy & coating	Silver (Ag)	7440-22-4		0.094	mg	9983	4519
				supplier	glue	Silver (Ag)	7440-22-4		0.026	mg	850000	1226
				supplier	glue	Carbocyclic acrylate (10-30%)	proprietary		0.003	mg	100000	144
				supplier	glue	2-Propenoic acid, 2-methyl-, 2-[[2,3,3a,4,7,7a]]	68586-19-6		0.001	mg	45000	65
				supplier	glue	2-(3,4-Epoxy)cyclohexyl)ethyltrimethoxysilane	3388-04-3		0.000	mg	5000	7
Bonding wires	M-008 Precious metals	0.100	mg	supplier	wire	Gold (Au)	7440-57-5		0.100	mg	1000000	4807
Encapsulation	M-011 Other inorganic materials	10.000	mg	supplier	mold compound	Epoxy Resin	proprietary		0.300	mg	30000	14423
				supplier	mold compound	Phenol Resin	proprietary		0.300	mg	30000	14423
				supplier	mold compound	Silica(Amorphous) A	60676-86-0		7.900	mg	790000	379808
				supplier	mold compound	Silica(Amorphous) B	7631-86-9		1.470	mg	147000	70673
				supplier	mold compound	Carbon Black	1333-86-4		0.030	mg	3000	1442
connections coating	Solder	0.130	mg	supplier	solder alloy	Tin (Sn)	7440-31-5		0.130	mg	1000000	6249